Low Power, Reduced EMI Clock Synthesizer

The NB2669A is a versatile spread spectrum frequency modulator designed specifically for a wide range of clock frequencies. The NB2669A reduces ElectroMagnetic Interference (EMI) at the clock source, allowing system wide reduction of EMI of all clock dependent signals. The NB2669A allows significant system cost savings by reducing the number of circuit board layers, ferrite beads and shielding that are traditionally required to pass EMI regulations.

The NB2669A uses the most efficient and optimized modulation profile approved by the FCC and is implemented by using a proprietary all digital method.

The NB2669A modulates the output of a single PLL in order to "spread" the bandwidth of a synthesized clock, and more importantly, decreases the peak amplitudes of its harmonics. This results in significantly lower system EMI compared to the typical narrow band signal produced by oscillators and most frequency generators. Lowering EMI by increasing a signal's bandwidth is called 'spread spectrum clock generation'.

The NB2669A is targeted towards all portable devices with very low power requirements like MP3 players and digital still cameras.

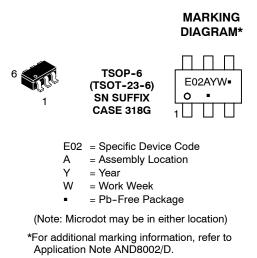
Features

- Generates an EMI Optimized Clocking Signal at the Output
- Integrated Loop Filter Components
- Operates with a 3.3 V / 2.5 V Supply
- Operating Current less than 4.0 mA
- Low Power CMOS Design
- Input Frequency Range: 6.0 MHz to 12 MHz for 2.5 V Input Frequency Range: 6.0 MHz to 13 MHz for 3.3 V
- Generates a 1X Low EMI Spread Spectrum clock of the Input Frequency
- Frequency Deviation $\pm 1\%$ @ 10 MHz
- Available in TSOP-6 Package (TSOT-23-6)
- Pb-Free Package is Available



ON Semiconductor®

http://onsemi.com



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

1

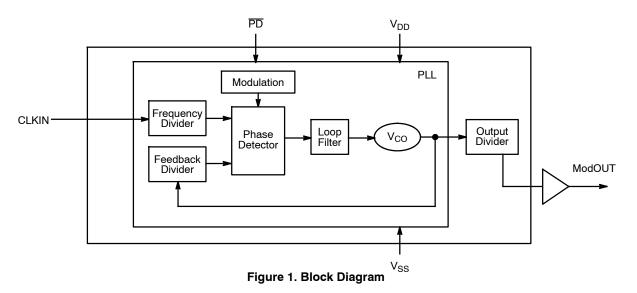


Table 1. KEY SPECIFICATIONS

Description		Specification
Supply Voltages		V _{DD} = 3.3 V / 2.5 V
Frequency Range	For 2.5 V Supply For 3.3 V Supply	6 MHz < CLKIN < 12 MHz 6 MHz < CLKIN < 13 MHz
Cycle-to-Cycle Jitter		200 ps (maximum)
Output Duty Cycle		45/55% (worst case)
Modulation Rate Equation		Fin/256
Frequency Deviation		±1% @ 10 MHz

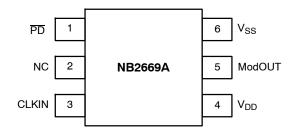


Figure 2. Pin Configuration

Table 2. PIN DESCRIPTION

Pin #	Pin Name	Туре	Description		
1	PD	I	Powerdown control pin. Pull low to enable Powerdown mode. Connect to V_{DD} if not used.		
2	NC		No connect.		
3	CLKIN	I	External reference frequency input.		
4	V _{DD}	Р	Power supply for the entire chip.		
5	ModOUT	0	Spread spectrum clock output.		
6	V _{SS}	Р	Ground connection.		

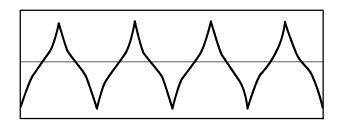


Figure 3. Modulation Profile

Table 3. MAXIMUM RATINGS

Symbol	Description	Rating	Unit
$V_{DD,}V_{IN}$	Voltage on any pin with respect to Ground	0.5 to + 7.0	V
T _{STG}	Storage Temperature	-65 to +125	°C
T _A	Operating Temperature	0 to 70	°C
T _s	Max. Soldering Temperature (10 sec)	260	°C
TJ	Junction Temperature	150	°C
T _{DV}	Static Discharge Voltage (As per MIL-STD-883, Method 3015)	2	kV

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 4. DC ELECTRICAL CHARACTERISTICS FOR 2.5 V SUPPLY (Test Conditions: All parameters are measured at room	
temperature 25°C)	

Symbol	Description	Min	Тур	Max	Unit
V _{IL}	Input LOW Voltage	GND - 0.3		0.8	V
V _{IH}	Input HIGH Voltage	2.0		V _{DD} + 0.3	V
IIL	Input LOW Current			-35	μA
I _{IH}	Input HIGH Current			35	μA
I _{XOL}	XOUT Output LOW Current (@ 0.5 V, V _{DD} = 2.5 V)		3.0		mA
I _{XOH}	XOUT Output HIGH Current (@ 1.8 V, V _{DD} = 2.5 V)		3.0		mA
V _{OL}	Output LOW Voltage (V _{DD} = 2.5 V, I _{OL} = 8.0 mA)			0.6	V
V _{OH}	Output HIGH Voltage (V _{DD} = 2.5 V, I _{OH} = 8.0 mA)	1.8			V
I _{DD}	Static Supply Current (Note 1)			10	μA
I _{CC}	Dynamic Supply Current (2.5 V, 10 MHz, and No Load)		2.0		mA
V _{DD}	Operating Voltage	2.375	2.5	2.625	V
t _{ON}	PLL first locked cycle time (Note 2)			5.0	mS
Z _{OUT}	Clock Output Impedance		50		Ω

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. XIN/CLKIN pin and PD pin are pulled low.

2. V_{DD} and CLKIN input are stable, PD pin is made high from low.

Table 5. AC ELECTRICAL CHARACTERISTICS FOR 2.5 V SUPPLY

Symbol	Description	Min	Тур	Max	Unit
CLKIN	Input Frequency	6.0		12	MHz
ModOUT	Output Frequency	6.0		12	MHz
f _d	Frequency DeviationInput Frequency = 6.0 MHzInput Frequency = 12 MHz			±1.48 ±0.79	%
t _{LH} (Note 3)	Output Rise Time (measured at 0.7 V to 1.7 V)	0.8	1.5	1.7	ns
t _{HL} (Note 3)	Output Fall Time (measured at 1.7 V to 0.7 V)	0.5	1.0	1.2	ns
t _{JC}	Jitter (Cycle-to-Cycle)			200	ps
t _D	Output Duty Cycle	45	50	55	%

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

3. t_{LH} and t_{HL} are measured at capacitive load of 15 pF.

Table 6. DC ELECTRICAL CHARACTERISTICS FOR 3.3 V SUPPLY (Test Conditions: All parameters are measured at room	n
temperature 25°C)	

Symbol	Description	Min	Тур	Max	Unit
V _{IL}	Input LOW Voltage	GND - 0.3		0.8	V
V _{IH}	Input HIGH Voltage	2.0		V _{DD} + 0.3	V
IIL	Input LOW Current			-35	μA
I _{IH}	Input HIGH Current			35	μA
I _{XOL}	XOUT Output LOW Current (@ 0.4 V, V _{DD} = 3.3 V)		3.0		mA
I _{XOH}	XOUT Output HIGH Current (@ 2.5 V, V _{DD} = 3.3 V)		3.0		mA
V _{OL}	Output LOW Voltage (V _{DD} = 3.3 V, I _{OL} = 8.0 mA)			0.4	V
V _{OH}	Output HIGH Voltage (V _{DD} = 3.3 V, I _{OH} = 8.0 mA)	2.5			V
I _{DD}	Static Supply Current (Note 4)			10	μA
I _{CC}	Dynamic Supply Current (3.3 V, 10 MHz, and No Load)		2.5		mA
V _{DD}	Operating Voltage	2.7	3.3	3.6	V
t _{ON}	PLL first locked cycle time (Note 5)			5.0	mS
Z _{OUT}	Clock Output Impedance		45		Ω

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

4. XIN/CLKIN pin and PD pin are pulled low.

5. V_{DD} and CLKIN input are stable, PD pin is made high from low.

Table 7. AC ELECTRICAL CHARACTERISTICS FOR 3.3 V SUPPLY

Symbol	Description	Min	Тур	Max	Unit
CLKIN	Input Frequency	6		13	MHz
ModOUT	Output Frequency	6		13	MHz
f _d	Frequency DeviationInput Frequency = 6.0 MHzInput Frequency = 13 MHz			±1.48 ±0.74	%
t _{LH} (Note 6)	Output Rise Time (measured at 0.8 V to 2.0 V)	0.5	1.3	1.5	ns
t _{HL} (Note 6)	Output Fall Time (measured at 2.0 V to 0.8 V)	0.4	0.9	1.1	ns
t _{JC}	Jitter (Cycle-to-Cycle)			200	ps
t _D	Output Duty Cycle	45	50	55	%

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

6. t_{LH} and t_{HL} are measured at capacitive load of 15 pF.

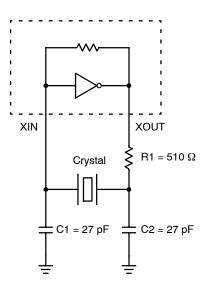


Figure 4. Typical Crystal Oscillator Circuit

Table 8. TYPICAL CRYSTAL SPECIFICATIONS

Fundamental AT Cut Parallel Resonant Crystal				
Nominal Frequency	14.31818 MHz			
Frequency Tolerance	±50 ppm or better at 25°C			
Operating Temperature Range	-25°C to +85°C			
Storage Temperature	-40°C to +85°C			
Load Capacitance	18 pF			
Shunt Capacitance	7 pF Maximum			
ESR	25 Ω			

ORDERING INFORMATION

Device	Marking	Temperature Range	Package	Shipping [†]	Availability
NB2669ASNR2	E02	0°C - 70°C	TSOP-6 (TSOT-23-6)	2500 Tape & Reel	Now
NB2669ASNR2G	E02	0°C - 70°C	TSOP-6 (TSOT-23-6) (Pb-Free)	2500 Tape & Reel	Contact Sales Representative

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





98ASB14888C	Electronic versions are uncontrolled except when accessed directly from the Document Repository Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.			
TSOP-6		PAGE 1 OF 1		
	98ASB14888C TSOP-6	98ASB14888C Printed versions are uncontrolled except when stamped "CONTROLLED		

ON Semiconductor and use trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights for dhers.

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor date sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use a a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor houteds for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

ON Semiconductor Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910 Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative